IN THE U.S. PATENT AND TRADEMARK OFFICE

May 7, 2001

Applicant(s):

Chikao IKENAGA et al.

For

FRAME FOR SEMICONDUCTOR PACKAGE

Attv. Docket No.: OPS Case 533

Assistant Commissioner for Patents

Washington, DC 20231

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AMENDMENT BEFORE FIRST OFFICE ACTION Sir:

Prior to issuance of the first Office Action in the above-identified application, kindly enter the following:

IN THE SPECIFICATION

Kindly amend Paragraphs 0014 and 0015, as indicated on the attached marked-up page. A replacement page, showing Paragraphs 0014 and 0015 in clean form, is also attached.

## REMARKS

The above Amendment is being submitted to conform the brief descriptions of Figures 3 and 4 with the drawing sheets.

Respectfully submitted,

Dale H. Thiel

DHT/ip

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Req. No. 24 323 Dale H. Thiel Req. No. 25 072 David G. Boutell Ronald J. Tanis Reg. No. 22 724 Reg. No. 32 549 Req. No. 36 589 Mark L. Maki David S. Goldenberg Req. No. 31 257 Sidney B. Williams, Jr. Reg. No. 24 949 Liane L. Churney Reg. No. 40 694 Reg. No. 36 328 Brian R. Tumm

Marked-up Paragraphs 0014 and 0015 (1 page) Replacement Paragraphs 0014 and 0015 (1 page)

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